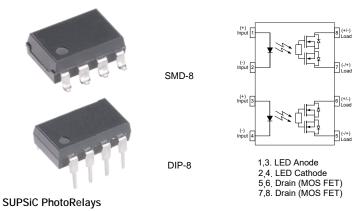
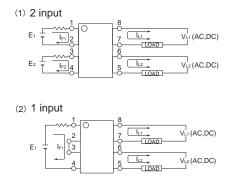
# **SUPSIC®**

Parameter	Symbol	Rating	Units	
Load Voltage	VL	60	V	
Load Current	lL .	0.40	Α	
On-Resistance	Ron	1	Ω	
I/O Isolation Voltage	V/ıo	5000	Vrms	







- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- · resistant to vibration and impact AC or DC load
- switching
- Small package size

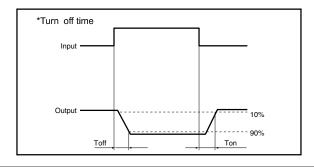
## **Applications**

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

#### **TPYES**

Category	Cotogoni	Output Rating		Doolsono	Part No.	Packing Quantity	
	Load Voltage	Load Current	Package	Part No.			
	AC/DC	60V	0.40A	DIP-8	GAQW412E	50pcs /tube	
AC/DC	60 V	0.40A	SMD-8	GAQW412EH	1000pcs /reel		





# Absolute Maximum Ratings (Ta = 25°C)

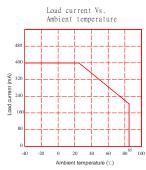
ltem		Symbol	Va <b>l</b> ue	Units	Note
	Continuous LED Current	<b>I</b> F	50	mA	
Input	Peak LED Current	<b>I</b> FP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	$V_{R}$	5	V	
	Input Power Dissipation	P <sub>In</sub>	75	mW	
	Load Voltage	VL	60	V(AC peak or DC)	
	Load Current	IL	0.40	Α	
Output	Peak Load Current	Peak	0.60	Α	1ms(1 pu <b>i</b> se)
	Output Power Dissipation	Pout	300	mW	
Total Power	Dissipation	Р⊤	350	mW	
I/O Isolation Voltage		Vi/o	5000	Vrms	RH=60%, 1min
Operating Temperature		Topr	-40 to 85	°C	
Storage Temperature		T <sub>stg</sub>	-40 to 100	°C	
Pin Soldering Temperature		T <sub>sol</sub>	260	°C	10 sec max.

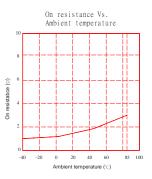
## Electrical Characteristics (Ta = 25°C)

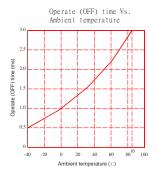
Item		Symbol	MIN.	TYP.	MAX.	Units	Conditions	
	LED Forward Voltage	VF		1.2	1.5	V	I⊧=10mA	
	Operation LED Current	Fon		0.5	3.0	mA		
Input	Recovery LED Current	Foff	0.1	0.4		mA		
	Recovery LED Voltage	V <sub>Foff</sub>	0.5			V		
							I⊧=5mA,I∟=Max	
	On-Resistance	Ron		1	3	Ω	Time to flow is within 1 sec.	
Output	Off-State Leakage	Leak		0.1		uA	V∟=Rating	
	Current	result					vi raang	
	Output Capacitance	Cout		165		pF	V∟=0, f=1MHz	
Transmis	Turn-On Time	Ton		0.50	1.5	ms	I⊧=5mA, I∟=Max	
sion	Turn-Off Time	Toff		0.25	2.0	ms		
Counted	I/O Isolation Resistance	R <sub>I/O</sub>	10 <sup>10</sup>			Ω	DC500V	
Coupled	I/O Capacitance	Ci/o		0.8		pF	f=1MHz	

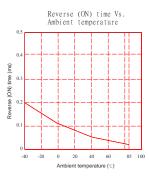
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

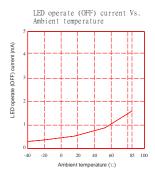
## **Engineering Data**

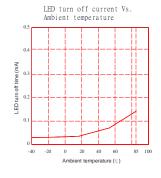


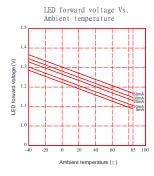


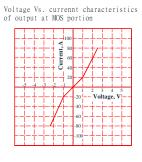


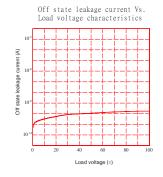


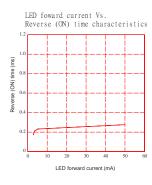


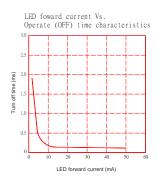




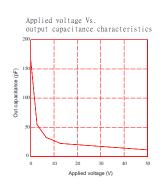








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**Rev 1.1** 

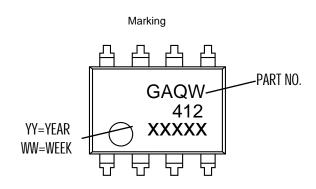
Dec.2016

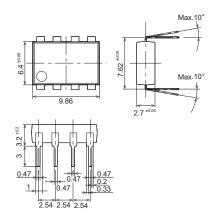


**Dimensions and DIP-8 Package** 

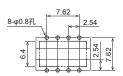
Unit: mm

## Through hole terminal type





PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.

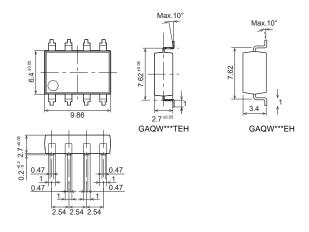




# Dimensions and SMD-8 Package Unit: mm

# Marking GAQW 412 YY=YEAR WW=WEEK WEEK

### Surface mount terminal type

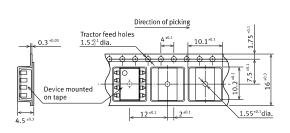


# Recommended mounting pad (Top view)

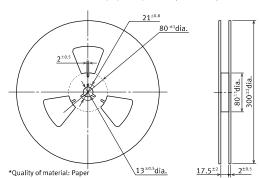


## Tape dimensions (tape reel)

Tape dimensions (Unit: mm)



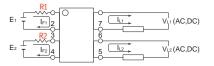
Dimensions of paper tape reel (Unit: mm)





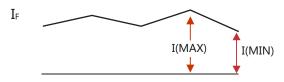
# **Using Methods**

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)				
3.3V	300 Ω				
5.0V	600 Ω				
12V	1.9K Ω				
24V	4.1K Ω				

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



#### **Recommended Operating Conditions**

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

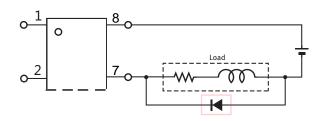
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

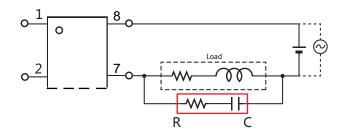
## **Protection Circuit**

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.



## **Recommended Soldering Conditions**

# (a) Infrared reflow soldering:

■ Peak reflow soldering : 260°C or below (package surface temperature)

■ Time of peak reflow temperature : 10 sec
 ■ Time of temperature higher than 230°C : 30-60 sec
 ■ Time to preheat temperature from 180~190°C : 60-120 sec

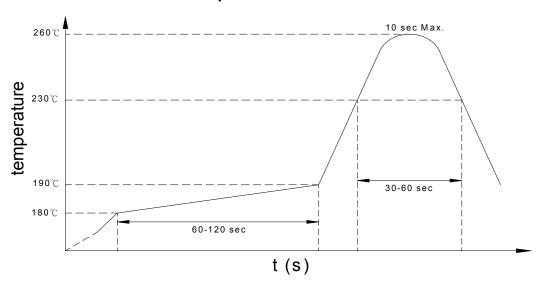
■ Time(s) of reflow: Two

■ Flux: Rosin flux containing small amount of chlorine (The

flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

# Recommended Temperature Profile of Infrared Reflow



# (b) Wave soldering:

■ Temperature : 260°C or below (molten solder temperature)

■ Time : 10 seconds or less

■ Preheating conditions : 120°C or below (package surface temperature)

■ Time(s) of reflow : One

■ Flux: Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(c) Cautions:

■ Fluxes : Avoid removing the residual flux with freon-based and chlorine-based

cleaning solvent.

Avoid shorting between portion of frame and leads.